

NCE07TD60BK

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600V, 7A, Trench FS II Fast IGBT

General Description:

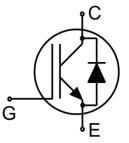
Using NCE's proprietary trench design and advanced FS (Field Stop) second generation technology, the 600V Trench FSII IGBT offers superior conduction and switching performances, and easy parallel operation;

Features

- Trench FSII Technology Offering
- Very low V_{CE(sat)}
- High speed switching
- Positive temperature coefficient in V_{CE(sat)}
- Very tight parameter distribution
- High ruggedness, temperature stable behavior

Application

- Air Condition
- Inverters
- Motor drives



Schematic diagram

Package Marking and Ordering Information

Device	Device Package	Device Marking
NCE07TD60BK	TO-252	NCE07TD60BK



TO-252

Absolute Maximum Ratings (T_C=25°C unless otherwise noted)

Symbol	Parameter	Value	Units	
Vces	Collector-Emitter Voltage	600	V	
V_{GES}	Gate- Emitter Voltage	±30	V	
1	Collector Current	14	А	
lc	Collector Current @T _C = 100 °C	7	А	
I _{Cplus}	Pulsed Collector Current, tp limited by Tjmax	21	А	
-	turn off safe operating area, V _{CE} =600V, T _J =150°C	21	А	
l _F	Diode Continuous Forward Current @T _C = 100 °C	7	А	
Іғм	Diode Maximum Forward Current	21	А	
-	Power Dissipation @ T _C = 25°C	73	W	
P _D	Power Dissipation @T _C = 100 °C	36.5	W	
T _J ,T _{stg}	Operating Junction and Storage Temperature Range	-55 to +175	°C	
TL	Maximum Temperature for Soldering	260	°C	
t _{sc}	Short circuit withstand time V _{GE} =15V, V _{CC} ≤400V, Allowed number of short circuits<1000Time between short circuits:≥1.0s,T _j ≤150°C	5	us	



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Thermal Characteristic

Symbol	Parameter	Value	Units
Rejc	Thermal Resistance, Junction to case for IGBT	2.05	°C/W
Rejc	Thermal Resistance, Junction to case for Diode	2.50	°C/W
ReJA	Thermal Resistance, Junction to Ambient	62	°C/W

Electrical Characteristics (Tc=25°C unless otherwise noted)

011	Barrantan			Value			
Symbol	Parameter Test Conditions		Min.	Тур.	Max.	Units	
Static Chara	cteristics				•		
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	V _{GE} =0V	,I _{CE} =1mA	600			V
Ices	Collector-Emitter Leakage Current	V _{GE} =0V,	Vce=600V			4	uA
I _{GES(F)}	Gate to Emitter Forward Leakage	V _{GE} =+30V,V _{CE} =0V				100	nA
I _{GES(R)}	Gate to Source Reverse Leakage	V _{GE} =-30	V,Vce =0V			100	nA
Vario	Collector Emitter Seturation Voltage	Ic=5A	Tj=25°C		1.7	1.9	V
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$V_{\text{GE}} = 15V$	Tj=100°C		1.9		V
$V_{\text{GE(th)}}$	Gate Threshold Voltage	Ic=1mA,VcE=VgE		4.0	5.0	6.0	V
ynamic Ch	aracteristics						
Cies	Input Capacitance	Vce=25V, Vge=0V, f=1MHz			675		pF
Coes	Output Capacitance				22		
C _{res}	Reverse Transfer Capacitance				13		
Qg	Total Gate Charge				28		
Q _{ge}	Gate to Emitter Charge	Vcc=480V, Ic=7A, Vg=15V			8		nC
Qgc	Gate to Collector Charge	VGL	-101		13		
I _{C(SC)}	Short circuit collector current Max.1000 short circuits Time between short circuits: ≥1.0s	V _{GE} =15V,V _{CC} ≤400V, t _{SC} ≤5us,Tj≤150°C			34		А
Switching Cl	naracteristics						
$t_{\text{d}(\text{ON})}$	Turn-on Delay Time				20		
t _r	Rise Time	Vcc=400V,Ic=7A,			15		ns
$t_{\text{d(OFF)}}$	Turn-Off Delay Time				73		115
t _f	Fall Time	V _{GE} =0/1	5V, R _g =5Ω		18		
Eon	Turn-On Switching Loss	Inducti	ive Load		0.21		
E _{off}	Turn-Off Switching Loss				0.10		mJ
Ets	Total Switching Loss				0.31		

Electrical Characteristics of the Diode(Tc= 25°C unless otherwise specified):

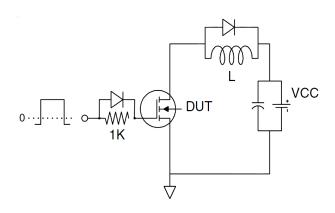
Cumbal	Parameter	Test Conditions	Rating			Units
Symbol		rest Conditions	Min.	Тур.	Max.	UIIIIS
V_{FM}	Diode Forward Voltage	I _F =7A		1.5	1.7	V
Trr	Reverse Recovery Time			230		ns
I _{RRM}	Diode Peak Reverse Recovery Current	I _F =7A, di/dt=200A/us		3.5		А
Qrr	Reverse Recovery Charge			0.44		uC
Pulse width $t_{tp} \le 380 \mu s$, $\delta \le 2\%$						



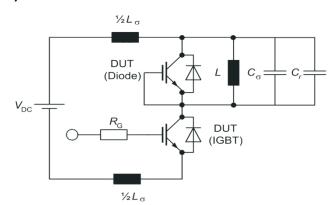
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Test Circuit

1) Gate Charge Test Circuit

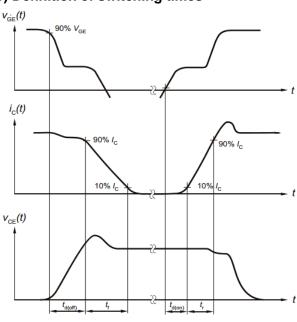


2) Switch Time Test Circuit

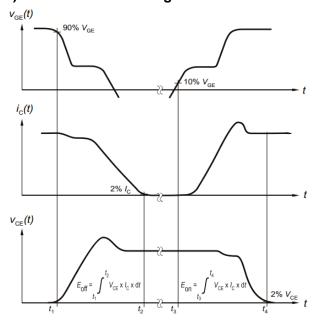


Switching characteristics

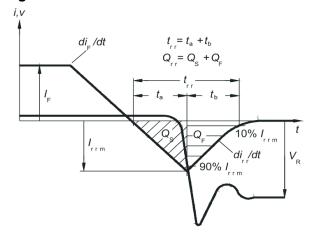
1) Definition of switching times



2) Definition of switching losses



3) Definition of diode switching characteristics



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Typical Electrical and Thermal Characteristics

Figure 1 Output Characteristics

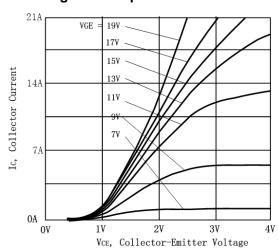


Figure 3 V_{CEsat} vs. Case Temperature

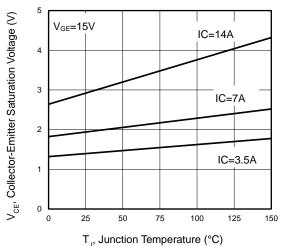


Figure 5 Capacitance Characteristics

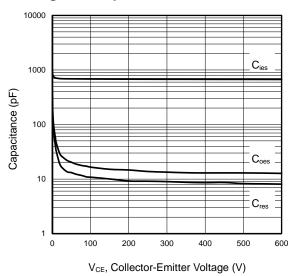


Figure 2 Transfer Characteristics

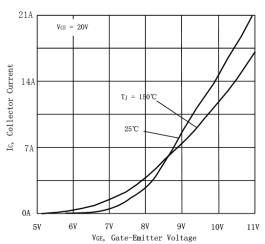


Figure 4 Saturation Voltage vs. V_{GE}

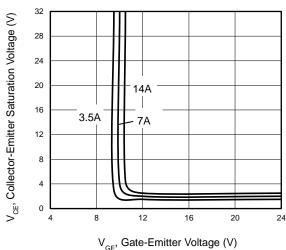
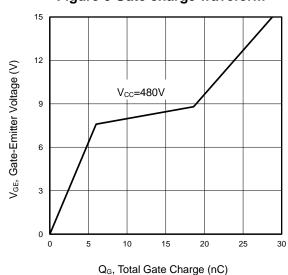


Figure 6 Gate charge waveform





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Typical Electrical and Thermal Characteristics

Figure 7 Forward Characteristics

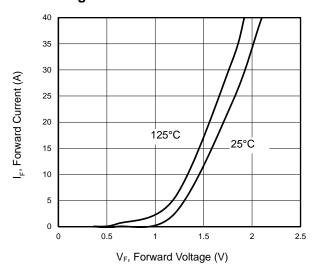


Figure 9 Typical Switching Times as a Function of Gate Resistor

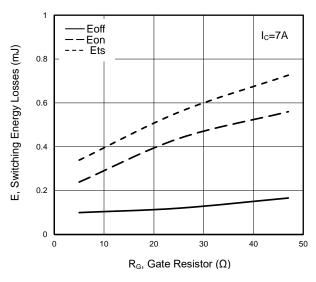


Figure 11 Gate-emitter Threshold Voltage as a Function of Junction Temperature

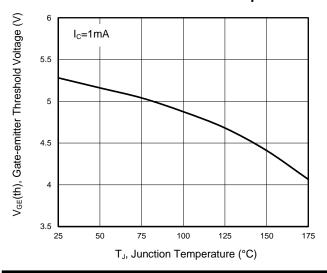


Figure 8 V_F vs. Temperature

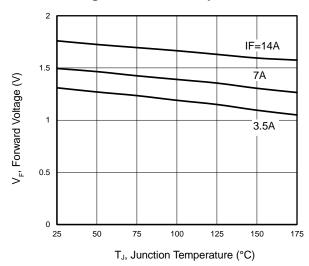


Figure 10 Typical Switching Times as a Function of Junction Temperature

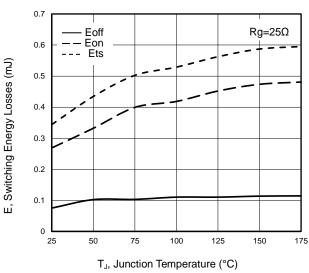
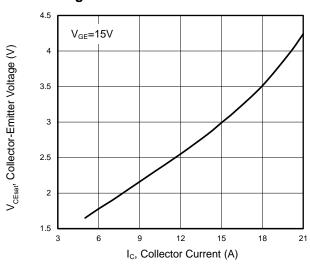


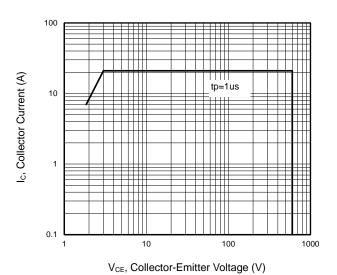
Figure 12 Typical Collector-emitter Saturation Voltage as a function of Collector Current





Typical Electrical and Thermal Characteristics

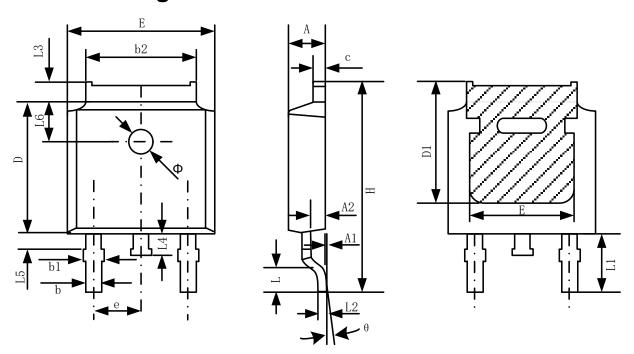
Figure 13 Forward Bias Safe Operating Area



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TO-252-2 Package Information



Cumbal	Dimensions	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.		
А	2.20	2.38	0.087	0.094		
A1	0.00	0.10	0.000	0.004		
A2	0.90	1.10	0.035	0.043		
b	0.72	0.85	0.028	0.033		
b1	0.72	0.90	0.028	0.035		
b2	5.13	5.46	0.202	0.215		
С	0.47	0.60	0.019	0.024		
D	6.00	6.20	0.236	0.244		
D1	5.25		0.207			
Е	6.50	6.70	0.256	0.264		
E1	4.70		0.185			
e	2.19	2.39	0.086	0.094		
Н	9.80	10.40	0.386	0.409		
L	1.40	1.70	0.055	0.067		
L1	2.90) REF	0.114	REF		
L2	0.50	8 BSC	0.020 BSC			
L3	0.90	1.25	0.035	0.049		
L4	0.60	1.00	0.024	0.039		
L5	0.15	0.75	0.006	0.030		
L6	1.80	1.80 REF		0.071 REF		
Ф	1.20	1.40	0.047	0.055		
θ	0°	8°	0°	0.31°		



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